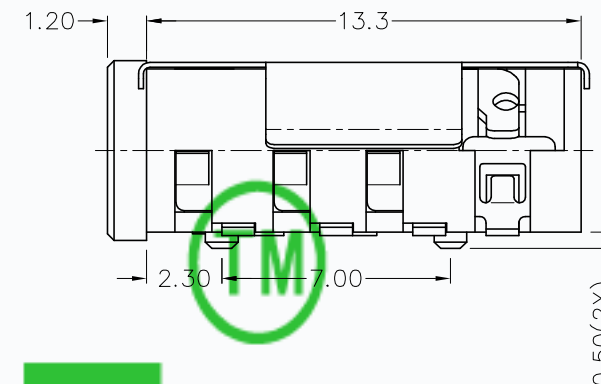
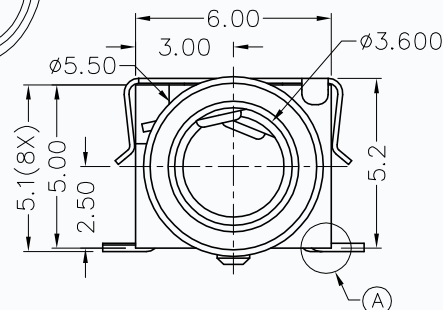
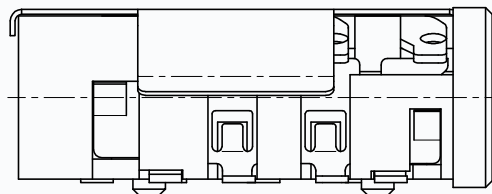
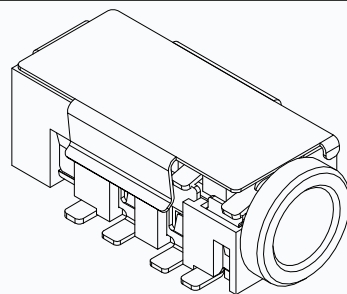


CAD FILE:

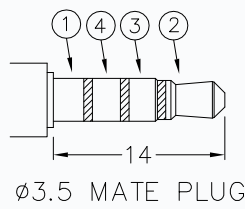
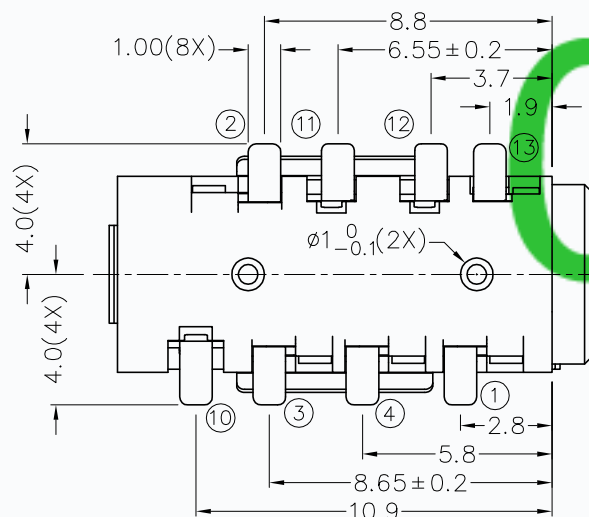
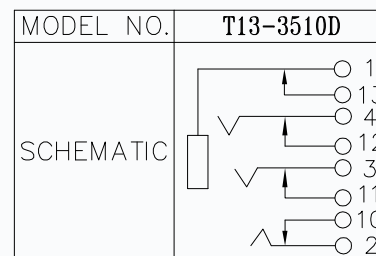


A DETAIL

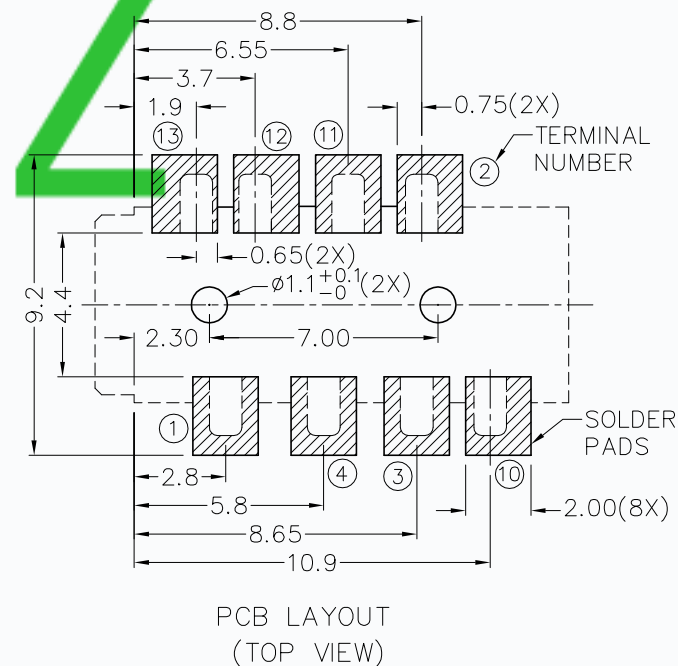
COPLANARITY

* MATERIAL

TERMINAL 1 : COPPER ALLOY
TERMINAL 2 : COPPER ALLOY
TERMINAL 3 : COPPER ALLOY
TERMINAL 4 : COPPER ALLOY
TERMINAL 10 : COPPER ALLOY
TERMINAL 11 : COPPER ALLOY
TERMINAL 12 : COPPER ALLOY
TERMINAL 13 : COPPER ALLOY
SHIELD : STAINLESS STEEL
HOUSING : PA6T



ø3.5 MATE PLUG

PCB LAYOUT
(TOP VIEW)

APPD. DESCRIPTIONS OF REVISION		TOLERANCE UNLESS SPECIFIED WITHIN 1.5mm : ±0.1mm OVER 1.5mm : ±0.2mm	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF DONGGUAN TIANDU ELECTRONICS CO.,LTD. AND SHALL NOT BE REPRODUCED. COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF DONGGUAN TIANDU ELECTRONICS CO., LTD.	TITLE : 3.5mm SMD PHONE JACK		UNIT : mm	DRWG NO.: CMTDDZ-T13-3510D-00		
				MODEL: T13-3510D		SCALE: 3:1	DWN.	ERIC	2013-6-17
				CMTDDZ 东莞市田都电子有限公司			CHK'D	MAIKO	2013-6-17
				DONGGUAN TIANDU ELECTRONICS CO.,LTD.			APPD.	Coco	2013-6-17